Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK3067

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• Low drain-source ON resistance : $R_{DS (ON)} = 4.2 \Omega (typ.)$

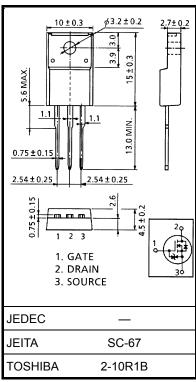
• High forward transfer admittance : |Y_{fs}| = 1.7 S (typ.)

• Low leakage current : I_{DSS} = 100 μA (max) (V_{DS} = 600 V)

• Enhancement mode : V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	600	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	600	V	
Gate-source voltage	ge	V _{GSS}	±30	V	
Drain current	DC (Note 1)	ΙD	2	Α	
	Pulse (t = 1 ms) (Note 1)	I _{DP}	5	А	
	Pulse (t = 100 μs) (Note 1)	I _{DP}	8	А	
Drain power dissipa	ation (Tc = 25°C)	P _D	25	W	
Single pulse avalar	nche energy (Note 2)	E _{AS}	93	mJ	
Avalanche current		I _{AR}	2	Α	
Repetitive avalanche energy (Note 3)		E _{AR}	2.5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Max	Unit
Thermal reverse, channel to case	R _{th (ch-c)}	5.0	°C/W
Thermal reverse, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 41 mH, R_G = 25 Ω , I_{AR} = 2 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature.

This transistor is an electrostatic-sensitive device. Please handle with caution.

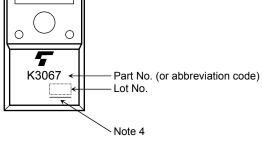
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μA
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V	_	_	100	μA
Drain-source br	eakdown voltage	V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	600	_	_	V
Gate threshold v	/oltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 1 A		4.2	5.0	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 1 A	0.8	1.7	_	S
Input capacitano	ce	C _{iss}			380	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		40	_	pF
Output capacitance		C _{oss}			120	_	
Switching time	Rise time	t _r	V_{GS} V_{OV} V_{OUT} V_{OUT} V_{OUT} V_{DD} V_{OUT}	_	15	_	
	Turn-on time	t _{on}		_	25	_	ne
	Fall time	t _f		l	20		ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\mathbf{W}} = 10 \mu s$		80	_	
Total gate charge (Gate-source plus gate-drain)		Qg	V _{DD} ≈ 480 V, V _{GS} = 10 V, I _D = 2 A		9	_	
Gate-source charge		Q _{gs}			5	_	nC
Gate-drain ("miller") charge		Q _{gd}			4	_	

Source-Drain Ratings and Characteristics (Tc = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current(Note 1)	I _{DR}	_	_	_	2	Α
Pulse drain reverse current (Note 1)	I _{DRP}	t = 1 ms	_	_	5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	t = 100 μs	1	1	8	Α
Forward voltage (diode)	V_{DSF}	I _{DR} = 2 A, V _{GS} = 0 V	1	1	-1.5	V
Reverse recovery time	t _{rr}	I _{DR} = 2 A, V _{GS} = 0 V dI _{DR} / dt = 100 A / μs	1	1000	1	ns
Reverse recovery charge	Q _{rr}		_	5.0	_	μC

Marking



Note 4: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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